

8961726 TEXAS INSTR (OPTO)

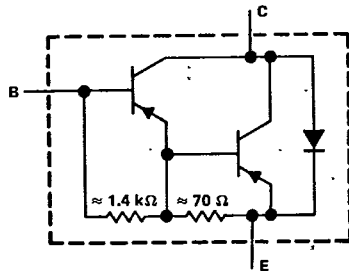
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BDX54, BDX54A, BDX54B, BDX54C
P-N-P SILICON POWER DARLINGTONS

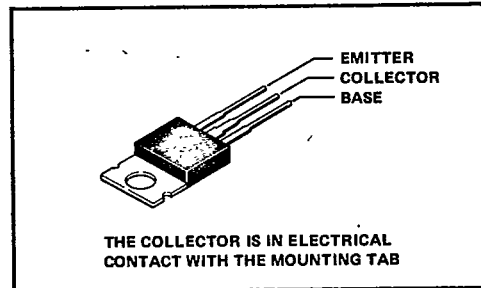
REVISED OCTOBER 1984

- 60 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Min h_{FE} of 750 at 3 V, 3 A

device schematic



TO-220AB PACKAGE



absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	BDX54	BDX54A	BDX54B	BDX54C
Collector-base voltage	-45 V	-60 V	-80 V	-100 V
Collector-emitter voltage ($I_B = 0$)	-45 V	-60 V	-80 V	-100 V
Emitter-base voltage			-5 V	
Continuous collector current			-8 A	
Continuous base current			-200 mA	
Continuous device dissipation at 25°C case temperature (see Note 1)			60 W	
Continuous device dissipation at 25°C free-air temperature (see Note 2)			2 W	
Operating free-air temperature range			-65°C to 150°C	
Operating collector junction and storage temperature range			-65°C to 150°C	

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.48 W/°C.
 2. Derate linearly to 150°C free-air temperature at the rate of 16 mW/°C.



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electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS	BDX54		BDX54A		BDX54B		BDX54C		UNIT	
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP		MAX
$V_{(BR)CEO}$	$I_C = -100 \text{ mA}, I_B = 0,$ See Note 3	-45			-60			-80		-100	V
I_{CEO}	$V_{CE} = -30 \text{ V}, I_B = 0$			-500				-500			μA
	$V_{CE} = -40 \text{ V}, I_B = 0$										
	$V_{CE} = -50 \text{ V}, I_B = 0$									-500	
I_{CBO}	$V_{CB} = -45 \text{ V}, I_E = 0$			-200							μA
	$V_{CB} = -60 \text{ V}, I_E = 0$					-200					
	$V_{CB} = -80 \text{ V}, I_E = 0$							-200			
	$V_{CB} = -100 \text{ V}, I_E = 0$									-200	
I_{EBO}	$V_{EB} = -5 \text{ V}, I_C = 0$			-2				-2		-2	mA
h_{FE}	$V_{CE} = -3 \text{ V}, I_C = -3 \text{ A},$ See Notes 3 and 4	750			750			750		750	
$V_{BE(sat)}$	$I_C = -3 \text{ A}, I_B = -12 \text{ mA},$ See Notes 3 and 4			-2.5				-2.5		-2.5	V
$V_{CE(sat)}$	$I_C = -3 \text{ A}, I_B = -12 \text{ mA},$ See Notes 3 and 4			-2				-2		-2	V
V_F	$I_F = 3 \text{ A}$			2.5				2.5		2.5	V

NOTES: 3. These parameters must be measured using pulse techniques, $t_w = 300 \mu\text{s}$, duty cycle $\leq 2\%$.
 4. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 3.2 mm (0.125 inch) from the device body.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$			2.08	
$R_{\theta JA}$			62.5	$^{\circ}\text{C/W}$

resistive-load switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{on}	$I_C = -3 \text{ A}, I_{B1} = -12 \text{ mA}, I_{B2} = 12 \text{ mA},$ $V_{BE(off)} = 4.2 \text{ V}, R_L = 10 \Omega,$ See Figure 1			1	μs
t_{off}				6	

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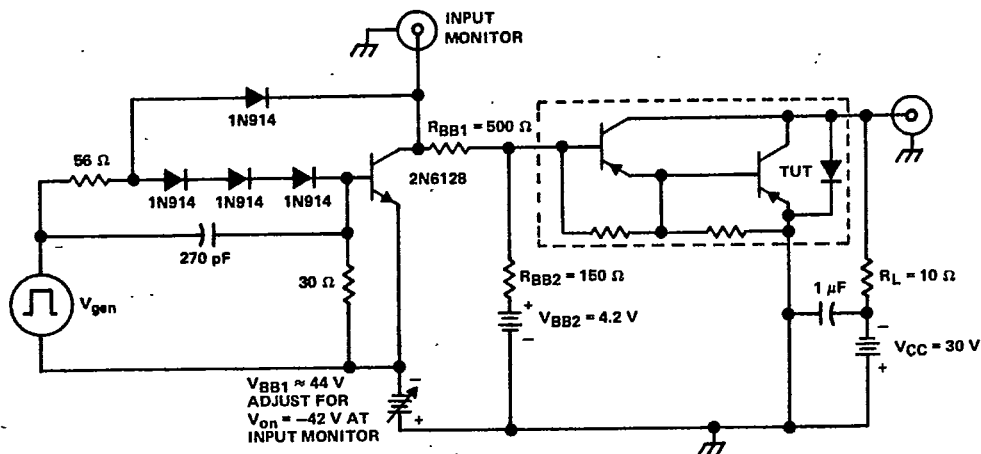
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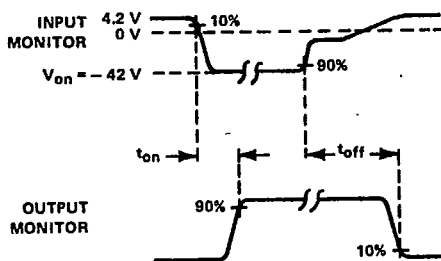
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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



VOLTAGE WAVEFORMS

- NOTES: A. V_{gen} is a 30-V pulse into a 50 Ω termination.
 B. The V_{gen} waveform is supplied by a generator with the following characteristics: $t_r < 15$ ns, $t_f < 15$ ns, $Z_{out} = 50 \Omega$, $t_w = 20 \mu$ s, duty cycle $\leq 2\%$.
 C. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r < 15$ ns, $R_{in} > 10$ M Ω , $C_{in} < 11.5$ pF.
 D. Resistors must be noninductive types.
 E. The d-c power supplies may require additional bypassing in order to minimize ringing.

FIGURE 1. RESISTIVE-LOAD SWITCHING



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TYPICAL CHARACTERISTICS



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STATIC FORWARD CURRENT TRANSFER RATIO
 vs
COLLECTOR CURRENT

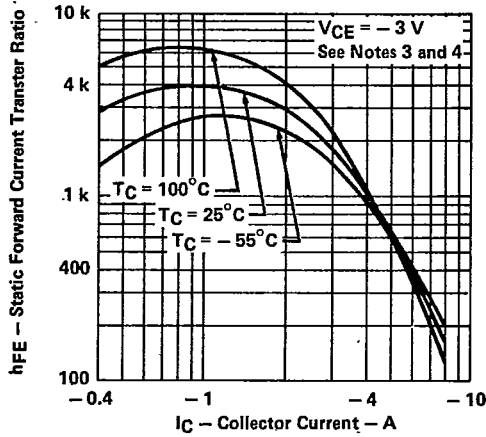


FIGURE 2

BASE-EMITTER VOLTAGE
 vs
CASE TEMPERATURE

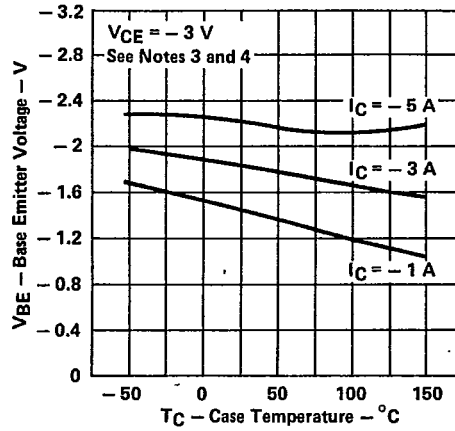


FIGURE 3

COLLECTOR-EMITTER SATURATION VOLTAGE
 vs
CASE TEMPERATURE

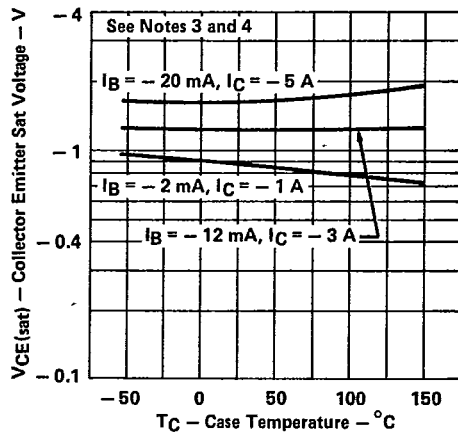


FIGURE 4

SMALL SIGNAL COMMON EMITTER
FORWARD CURRENT TRANSFER RATIO
 vs
FREQUENCY

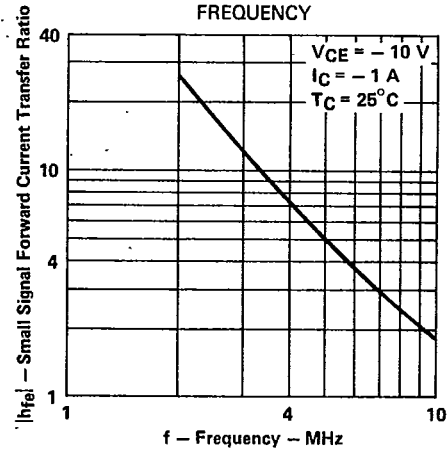


FIGURE 5

- NOTES:**
3. These parameters must be measured using pulse techniques, $t_w = 300 \mu s$, duty cycle $\leq 2\%$.
 4. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 3,2 mm (0.125 inch) from the device body.

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MAXIMUM SAFE OPERATING AREA
MAXIMUM COLLECTOR CURRENT
vs
COLLECTOR-EMITTER VOLTAGE

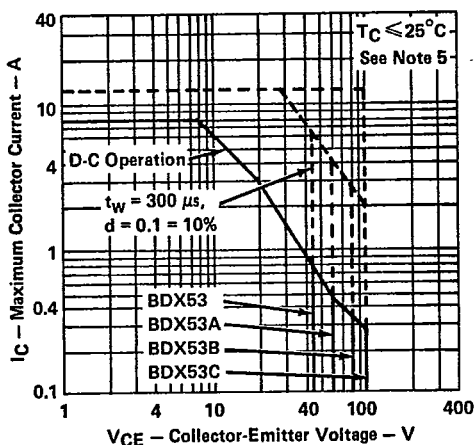


FIGURE 6

NOTE 5: This combination of maximum voltage and current may be achieved only when switching from saturation to cutoff with a clamped inductive load.

THERMAL INFORMATION

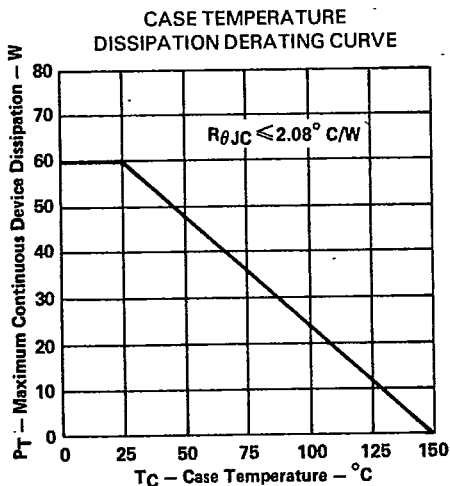


FIGURE 7

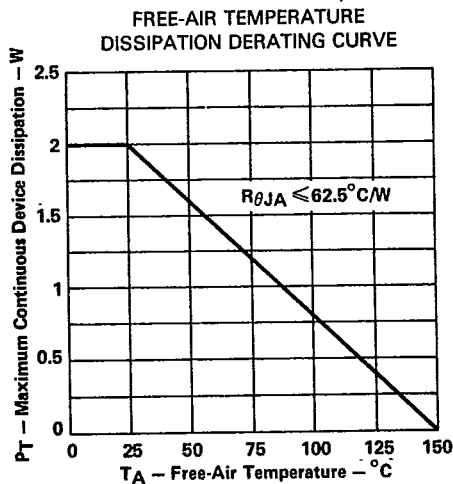


FIGURE 8



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